

# CMOS Low Voltage 4 $\Omega$ SPDT Switch

**ADG719** 

#### **FEATURES**

+1.8 V to +5.5 V Single Supply 4  $\Omega$  (Max) On Resistance 0.75  $\Omega$  (Typ) On-Resistance Flatness -3 dB Bandwidth >200 MHz Rail-to-Rail Operation 6-Lead SOT-23 Package, 8-Lead  $\mu$ SOIC Package Fast Switching Times  $t_{ON}$  20 ns  $t_{OFF}$  6 ns Typical Power Consumption (<0.01  $\mu$ W)

APPLICATIONS
Battery Powered Systems
Communication Systems
Sample Hold Systems
Audio Signal Routing
Video Switching
Mechanical Reed Relay Replacement

#### **GENERAL DESCRIPTION**

TTL/CMOS Compatible

The ADG719 is a monolithic CMOS SPDT switch. This switch is designed on a submicron process that provides low power dissipation yet gives high switching speed, low on resistance and low leakage currents.

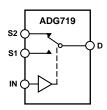
The ADG719 can operate from a single supply range of +1.8 V to +5.5 V, making it ideal for use in battery-powered instruments and with the new generation of DACs and ADCs from Analog Devices.

Each switch of the ADG719 conducts equally well in both directions when on. The ADG719 exhibits break-before-make switching action.

Because of the advanced submicron process, -3 dB bandwidths of greater than 200 MHz can be achieved.

The ADG719 is available in a 6-lead SOT-23 package and an 8-lead  $\mu$ SOIC package.

#### **FUNCTIONAL BLOCK DIAGRAM**



SWITCHES SHOWN FOR A LOGIC "1" INPUT

#### **PRODUCT HIGHLIGHTS**

- 1. +1.8 V to +5.5 V Single Supply Operation. The ADG719 offers high performance, including low on resistance and fast switching times and is fully specified and guaranteed with +3 V and +5 V supply rails.
- 2. Very Low  $R_{ON}$  (4  $\Omega$  max at 5 V, 10  $\Omega$  max at 3 V). At 1.8 V operation,  $R_{ON}$  is typically 40  $\Omega$  over the temperature range.
- 3. On-Resistance Flatness ( $R_{FLAT(ON)}$ ) (0.75  $\Omega$  typ).
- 4. −3 dB Bandwidth >200 MHz.
- Low Power Dissipation. CMOS construction ensures low power dissipation.
- Fast t<sub>ON</sub>/t<sub>OFF</sub>.
- 7. Tiny 6-lead SOT-23 and 8-lead µSOIC packages.

#### REV. A

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One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106, U.S.A. Tel: 781/329-4700 World Wide Web Site: http://www.analog.com Fax: 781/326-8703 © Analog Devices, Inc., 1998

# **ADG719—SPECIFICATIONS**<sup>1</sup> ( $V_{DD} = +5 \text{ V} \pm 10\%$ , GND = 0 V. All specifications $-40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$ , unless otherwise noted.)

	B Version				
Parameter	+25°C	-40°C to +85°C	Units	Test Conditions/Comments	
ANALOG SWITCH Analog Signal Range On Resistance (R <sub>ON</sub> )	4	0 V to V <sub>DD</sub>	V Ω max	$V_S = 0 \text{ V to } V_{DD}, I_S = -10 \text{ mA}$ Test Circuit 1	
On Resistance Match Between Channels ( $\Delta R_{ON}$ )  On-Resistance Flatness ( $R_{FLAT(ON)}$ )	0.75	0.1 0.4 1.2	$\Omega$ typ $\Omega$ max $\Omega$ typ $\Omega$ max	$V_S = 0 \text{ V to } V_{DD}, I_S = -10 \text{ mA}$ $V_S = 0 \text{ V to } V_{DD}, I_S = -10 \text{ mA}$	
LEAKAGE CURRENTS Source OFF Leakage $I_S$ (OFF)  Channel ON Leakage $I_D$ , $I_S$ (ON)	$\pm 0.01$ $\pm 0.25$ $\pm 0.01$ $\pm 0.25$	±0.35 ±0.35	nA typ nA max nA typ nA max	$V_{\rm DD}$ = +5.5 V $V_{\rm S}$ = 4.5 V/1 V, $V_{\rm D}$ = 1 V/4.5 V Test Circuit 2 $V_{\rm S}$ = $V_{\rm D}$ = 1 V, or $V_{\rm S}$ = $V_{\rm D}$ = 4.5 V Test Circuit 3	
DIGITAL INPUTS Input High Voltage, $V_{INH}$ Input Low Voltage, $V_{INL}$ Input Current $I_{INL}$ or $I_{INH}$	0.005	2.4 0.8 ±0.1	V min V max µA typ uA max	$V_{IN} = V_{INL}$ or $V_{INH}$	
DYNAMIC CHARACTERISTICS <sup>2</sup> t <sub>ON</sub>	14	20.1	ns typ	$R_{L} = 300 \Omega, C_{L} = 35 pF$	
t <sub>OFF</sub>	3	20 6	ns max ns typ ns max	$V_S = 3$ V, Test Circuit 4 $R_L = 300 \Omega$ , $C_L = 35$ pF $V_S = 3$ V, Test Circuit 4	
Break-Before-Make Time Delay, t <sub>D</sub>	8	1	ns typ ns min	$R_L = 300 \Omega$ , $C_L = 35 pF$ , $V_{S1} = V_{S2} = 3 V$ , Test Circuit 5	
Off Isolation  Channel-to-Channel Crosstalk	-67 -87 -62 -82		dB typ dB typ dB typ dB typ dB typ	$R_{L} = 50 \ \Omega, C_{L} = 5 \ pF, f = 10 \ MHz$ $R_{L} = 50 \ \Omega, C_{L} = 5 \ pF, f = 1 \ MHz,$ Test Circuit 6 $R_{L} = 50 \ \Omega, C_{L} = 5 \ pF, f = 10 \ MHz$ $R_{L} = 50 \ \Omega, C_{L} = 5 \ pF, f = 1 \ MHz,$	
Bandwidth –3 dB C <sub>S</sub> (OFF) C <sub>D</sub> , C <sub>S</sub> (ON)	200 7 27		MHz typ pF typ pF typ	Test Circuit 7 $R_L = 50 \Omega$ , $C_L = 5 pF$ , Test Circuit 8	
POWER REQUIREMENTS				$V_{DD} = +5.5 \text{ V}$ Digital Inputs = 0 V or 5 V	
${ m I}_{ m DD}$	0.001	1.0	μΑ typ μΑ max	g 2p a 0 , 02 9 ,	

#### NOTES

Specifications subject to change without notice.

<sup>&</sup>lt;sup>1</sup>Temperature ranges are as follows: B Version, -40°C to +85°C.

<sup>&</sup>lt;sup>2</sup>Guaranteed by design, not subject to production test.

# $\label{eq:continuous} \textbf{SPECIFICATIONS}^{1}(\textbf{V}_{DD} = +3~\textbf{V} \pm~10\%,~\textbf{GND} = 0~\textbf{V}.~~\textbf{All specifications} -40^{\circ}\text{C to}~+85^{\circ}\text{C},~\textbf{unless otherwise noted.})$

	B Version				
Parameter	+25°C	-40°C to +85°C	Units	Test Conditions/Comments	
ANALOG SWITCH					
Analog Signal Range		0 V to V <sub>DD</sub>	V		
On Resistance (R <sub>ON</sub> )	6	7	$\Omega$ typ	$V_{S} = 0 \text{ V to } V_{DD}, I_{S} = -10 \text{ mA},$	
		10	$\Omega$ max	Test Circuit 1	
On Resistance Match Between					
Channels ( $\Delta R_{ON}$ )		0.1	$\Omega$ typ	$V_S = 0 \text{ V to } V_{DD}, I_S = -10 \text{ mA}$	
		0.4	$\Omega$ max		
On-Resistance Flatness (R <sub>FLAT(ON)</sub> )		2.5	Ω typ	$V_S = 0 \text{ V to } V_{DD}, I_S = -10 \text{ mA}$	
LEAKAGE CURRENTS				$V_{\rm DD} = +3.3 \text{ V}$	
Source OFF Leakage I <sub>S</sub> (OFF)	±0.01		nA typ	$V_S = 3 \text{ V/1 V}, V_D = 1 \text{ V/3 V},$	
	±0.25	±0.35	nA max	Test Circuit 2	
Channel ON Leakage I <sub>D</sub> , I <sub>S</sub> (ON)	±0.01		nA typ	$V_S = V_D = 1 \text{ V, or } V_S = V_D = 3 \text{ V,}$	
	±0.25	±0.35	nA max	Test Circuit 3	
DIGITAL INPUTS					
Input High Voltage, V <sub>INH</sub>		2.0	V min		
Input Low Voltage, V <sub>INL</sub>		0.4	V max		
Input Current					
I <sub>INL</sub> or I <sub>INH</sub>	0.005		μA typ	$V_{IN} = V_{INL}$ or $V_{INH}$	
		±0.1	μA max		
DYNAMIC CHARACTERISTICS <sup>2</sup>					
$t_{ON}$	16		ns typ	$R_L = 300 \Omega, C_L = 35 pF$	
		24	ns max	$V_S = 2 V$ , Test Circuit 4	
$t_{ m OFF}$	4		ns typ	$R_L = 300 \Omega, C_L = 35 pF$	
	_	7	ns max	$V_S = 2 V$ , Test Circuit 4	
Break-Before-Make Time Delay, t <sub>D</sub>	8	_	ns typ	$R_L = 300 \Omega, C_L = 35 pF$	
OCT 1	67	1	ns min	$V_{S1} = V_{S2} = 2 \text{ V}$ , Test Circuit 5	
Off Isolation	-67 -07		dB typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ , $f = 10 MHz$	
	-87		dB typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ , $f = 1 MHz$ , Test Circuit 6	
Channel-to-Channel Crosstalk	-62		dB typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ , $f = 10 MHz$	
Chamber to Chamber Greechan	-82		dB typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ , $f = 1 MHz$ ,	
			JF	Test Circuit 7	
Bandwidth -3 dB	200		MHz typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ , Test Circuit 8	
$C_{S}$ (OFF)	7		pF typ		
$C_D$ , $C_S$ (ON)	27		pF typ		
POWER REQUIREMENTS				$V_{\rm DD} = +3.3 \text{ V}$	
•				Digital Inputs = 0 V or 3 V	
$I_{\mathrm{DD}}$	0.001		μA typ		
		1.0	μA max		

#### NOTES

REV. A -3-

<sup>&</sup>lt;sup>1</sup>Temperature ranges are as follows: B Version, -40°C to +85°C.

<sup>&</sup>lt;sup>2</sup>Guaranteed by design, not subject to production test.

Specifications subject to change without notice.

#### **ADG719**

#### ABSOLUTE MAXIMUM RATINGS1

$(T_A = +25^{\circ}C \text{ unless otherwise noted})$
$V_{DD}$ to GND
Analog, Digital Inputs <sup>2</sup> $-0.3 \text{ V}$ to $V_{DD} + 0.3 \text{ V}$ or
30 mA, Whichever Occurs First
Peak Current, S or D 100 mA
(Pulsed at 1 ms, 10% Duty Cycle max)
Continuous Current, S or D
Operating Temperature Range
Industrial (B Version)40°C to +85°C
Storage Temperature Range65°C to +150°C
Junction Temperature +150°C
μSOIC Package, Power Dissipation
$\theta_{JA}$ Thermal Impedance
$\theta_{JC}$ Thermal Impedance
SOT-23 Package, Power Dissipation 282 mW
$\theta_{JA}$ Thermal Impedance
$\theta_{\rm JC}$ Thermal Impedance
Lead Temperature, Soldering
Vapor Phase (60 sec) +215°C
Infrared (15 sec) +220°C
ESD

#### NOTES

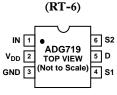
<sup>1</sup>Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Only one absolute maximum rating may be applied at any one time.

<sup>2</sup>Overvoltages at IN, S or D will be clamped by internal diodes. Current should be limited to the maximum ratings given.

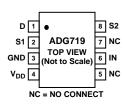
Table I. Truth Table

ADG719 IN	Switch S1	Switch S2
0	ON	OFF
1	OFF	ON

#### PIN CONFIGURATIONS



6-Lead SOT-23



8-Lead μSOIC (RM-8)

#### **TERMINOLOGY**

$\overline{\mathrm{V}_{\mathrm{DD}}}$	Most Positive Power Supply Potential.
GND	Ground (0 V) Reference.
S	Source Terminal. May be an input or output.
D	Drain Terminal. May be an input or output.
IN	Logic Control Input.
$R_{ON}$	Ohmic resistance between D and S.
$\Delta R_{\rm ON}$	On resistance match between any two channels i.e., $R_{ON}$ max – $R_{ON}$ min.
$R_{FLAT\left(ON\right)}$	Flatness is defined as the difference between the maximum and minimum value of on resistance as measured over the specified analog signal range.
I <sub>S</sub> (OFF)	Source Leakage Current with the switch "OFF."
$I_D, I_S (ON)$	Channel Leakage Current with the switch "ON."
$V_{D}(V_{S})$	Analog Voltage on Terminals D, S.
$C_{S}$ (OFF)	"OFF" Switch Source Capacitance.
$C_D$ (OFF)	"OFF" Switch Drain Capacitance.
$C_D$ , $C_S$ (ON)	"ON" Switch Capacitance.
$t_{ON}$	Delay between applying the digital control input and the output switching on.
t <sub>OFF</sub>	Delay between applying the digital control input and the output switching off.
$t_D$	"OFF" time or "ON" time measured between the 90% points of both switches, when switching from one address state to another.
Crosstalk	A measure of unwanted signal that is coupled through from one channel to another as a result of parasitic capacitance.
Off Isolation	A measure of unwanted signal coupling through an "OFF" switch.
Bandwidth	The frequency at which the output is attenuated by $-3$ dBs.
On Response	The frequency reponse of the "ON" switch.
On Loss	The voltage drop across the "ON" switch seen on the On Response vs. Frequency plot as how many dBs the signal is away from 0 dB at very low frequencies.

#### **ORDERING GUIDE**

Model	Temperature Range	Brand*	Package Description	Package Option
ADG719BRM	−40°C to +85°C	S5B	μSOIC (microSmall Outline IC)	RM-8
ADG719BRT	−40°C to +85°C	S5B	SOT-23 (Plastic Surface Mount)	RT-6

 $<sup>\</sup>star$ Brand = Due to package size limitations, these three characters represent the part number.

#### CAUTION \_

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the ADG719 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



# **Typical Performance Characteristics—ADG719**

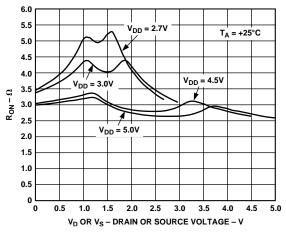


Figure 1. On Resistance as a Function of  $V_D$  ( $V_S$ ) Single Supplies

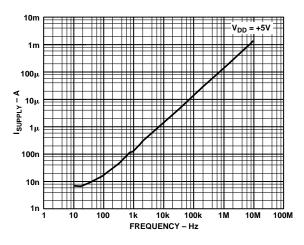


Figure 4. Supply Current vs. Input Switching Frequency

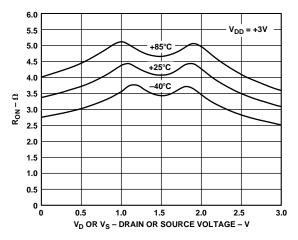


Figure 2. On Resistance as a Function of  $V_D$  ( $V_S$ ) for Different Temperatures  $V_{DD} = 3 \ V$ 

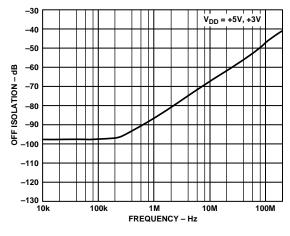


Figure 5. Off Isolation vs. Frequency

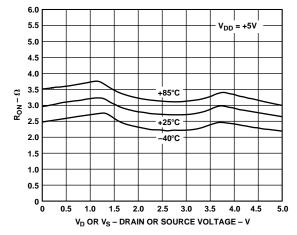


Figure 3. On Resistance as a Function of  $V_D$  ( $V_S$ ) for Different Temperatures  $V_{DD} = 5 \ V$ 

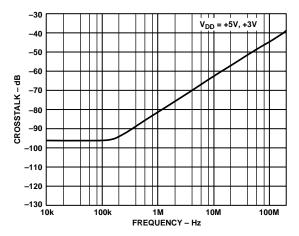


Figure 6. Crosstalk vs. Frequency

REV. A -5-

### **ADG719**

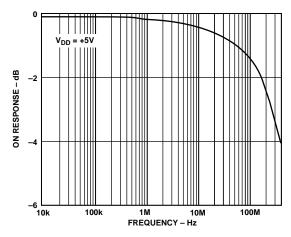
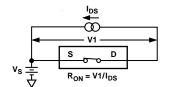
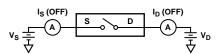


Figure 7. On Response vs. Frequency

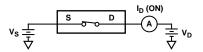
### **Test Circuits**



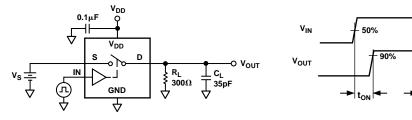
Test Circuit 1. On Resistance



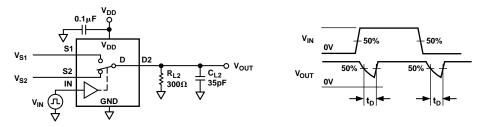
Test Circuit 2. Off Leakage



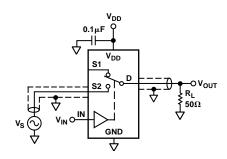
Test Circuit 3. On Leakage



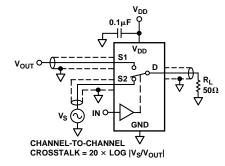
Test Circuit 4. Switching Times



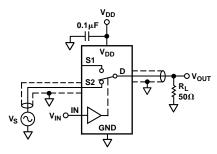
Test Circuit 5. Break-Before-Make Time Delay, t<sub>D</sub>



Test Circuit 6. Off Isolation



Test Circuit 7. Channel-to-Channel Crosstalk



Test Circuit 8. Bandwidth

#### APPLICATIONS INFORMATION

The ADG719 belongs to Analog Devices' new family of CMOS switches. This series of general purpose switches have improved switching times, lower on resistance, higher bandwidths, low power consumption and low leakage currents.

#### **ADG719 Supply Voltages**

Functionality of the ADG719 extends from +1.8 V to +5.5 V single supply, which makes it ideal for battery powered instruments, where important design parameters are power efficiency and performance.

It is important to note that the supply voltage effects the input signal range, the on resistance and the switching times of the part. By taking a look at the typical performance characteristics and the specifications, the effects of the power supplies can be clearly seen.

For  $V_{DD}$  = +1.8 V operation,  $R_{ON}$  is typically 40  $\Omega$  over the temperature range.

#### On Response vs. Frequency

Figure 8 illustrates the parasitic components that affect the ac performance of CMOS switches (the switch is shown surrounded by a box). Additional external capacitances will further degrade some performance. These capacitances affect feedthrough, crosstalk and system bandwidth.

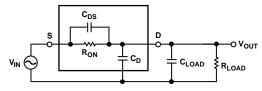


Figure 8. Switch Represented by Equivalent Parasitic Components

The transfer function that describes the equivalent diagram of the switch (Figure 8) is of the form (A)s shown below.

$$A(s) = R_T \left[ \frac{s(R_{ON} \ C_{DS}) + 1}{s(R_T \ R_{ON} \ C_T) + 1} \right]$$

where:

$$R_T = R_{LOAD}/(R_{LOAD} + R_{ON})$$
  

$$C_T = C_{LOAD} + C_D + C_{DS}$$

The signal transfer characteristic is dependent on the switch channel capacitance,  $C_{DS}$ . This capacitance creates a frequency zero in the numerator of the transfer function A(s). Because the switch on resistance is small, this zero usually occurs at high frequencies. The bandwidth is a function of the switch output capacitance combined with  $C_{DS}$  and the load capacitance. The frequency pole corresponding to these capacitances appears in the denominator of A(s).

The dominant effect of the output capacitance,  $C_D$ , causes the pole breakpoint frequency to occur first. Therefore, in order to maximize bandwidth a switch must have a low input and output capacitance and low on resistance. The On Response vs. Frequency plot for the ADG719 can be seen in Figure 7.

#### Off Isolation

Off isolation is a measure of the input signal coupled through an off switch to the switch output. The capacitance,  $C_{DS}$ , couples the input signal to the output load, when the switch is off as shown in Figure 9.

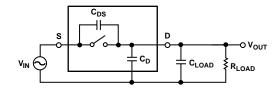


Figure 9. Off Isolation Is Affected by External Load Resistance and Capacitance

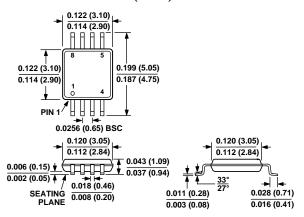
The larger the value of  $C_{DS}$ , larger values of feedthrough will be produced. The typical performance characteristic graph of Figure 5 illustrates the drop in off isolation as a function of frequency. From dc to roughly 200 kHz, the switch shows better than –95 dB isolation. Up to frequencies of 10 MHz, the off isolation remains better than –67 dB. As the frequency increases, more and more of the input signal is coupled through to the output. Off isolation can be maximized by choosing a switch with the smallest  $C_{DS}$  as possible. The values of load resistance and capacitance affect off isolation also, as they contribute to the coefficients of the poles and zeros in the transfer function of the switch when open.

$$A(s) = \left[ \frac{s(R_{LOAD} \ C_{DS})}{s(R_{LOAD}) (C_{LOAD} + C_D + C_{DS}) + 1} \right]$$

#### **OUTLINE DIMENSIONS**

Dimensions shown in inches and (mm).

# 8-Lead μSOIC (RM-8)



# 6-Lead Plastic Surface Mount Package (RT-6)

